

CEB540L-VB Datasheet

N-Channel 100-V (D-S) MOSFET

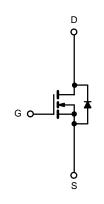
PRODUCT SUMMARY					
V _{(BR)DSS} (V)	r _{DS(on)} (Ω)	I _D (A)			
100	0.030 at V _{GS} = 10 V	45			
	0.035 at V _{GS} = 4.5 V	40			

FEATURES

- Trench Power MOSFETS
- 175 °C Junction Temperature
- Low Thermal Resistance Package







N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	T _C = 25 °C, unless oth	erwise noted			
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	100	V	
Gate-Source Voltage		V _{GS}	± 20	- v	
Continuous Drain Current ($T_1 = 175 \text{ °C}$)	$T_{C} = 25 \text{ °C}$ $T_{C} = 125 \text{ °C}$	1-	45		
Continuous Drain Current $(1) = 175$ C)	T _C = 125 °C	I _D	30	٨	
Pulsed Drain Current		I _{DM}	135	- A	
Avalanche Current		I _{AR}	35		
Repetitive Avalanche Energy ^a	L = 0.1 mH	E _{AR}	61	mJ	
	T _C = 25 °C	P	127 ^b		
Maximum Power Dissipation ^a	T _A = 25 °C ^c	– P _D –	3.75	W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Limit	Unit	
Junction-to-Ambient	(PCB Mount) ^c	R _{thJA}	40	°C/W	
Junction-to-Case (Drain)		R _{thJC}	1.4	5/2	

Notes:

a. Duty cycle \leq 1 %.

b. See SOA curve for voltage derating.

c. When Mounted on 1" square PCB (FR-4 material).

* Pb containing terminations are not RoHS compliant, exemptions may apply.

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static			<u> </u>				
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{SS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	100				
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	1		3	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = 80 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 80 V, V _{GS} = 0 V, T _J = 125 °C			50	μA	
		V _{DS} = 80 V, V _{GS} = 0 V, T _J = 175 °C			250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	75			А	
		V _{GS} = 10 V, I _D = 5 A		0.030			
	_	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 3 \text{ A}$		0.035			
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = 10 V, I _D = 5 A, T _J = 125 °C		0.050		Ω	
		V _{GS} = 10 V, I _D = 3 A, T _J = 175 °C		0.062			
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A	10			S	
Dynamic ^b	+			+			
Input Capacitance	C _{iss}			3100		pF	
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz		410			
Reverse Transfer Capacitance	C _{rss}			150			
Total Gate Charge ^c	Qg			35	60	nC	
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 50 V, V_{GS} = 10 V, I_D = 40 A		11			
Gate-Drain Charge ^c	Q _{gd}			9			
Gate Resistance	R _G			1.7		Ω	
Turn-On Delay Time ^c	t _{d(on)}			11	20		
Rise Time ^c	t _r	V_{DD} = 50 V, R_L = 1.25 Ω		12	20	ns	
Turn-Off Delay Time ^c	t _{d(off)}	$\text{I}_\text{D}{\cong}40$ A, V_GEN = 10 V, R_G = 2.5 Ω		30	45		
Fall Time ^c	t _f			12	20		
Source-Drain Diode Ratings and Cha	aracteristics T	$C = 25 \ ^{\circ}C^{b}$					
Continuous Current	ا _S				40	А	
Pulsed Current	I _{SM}				120		
Forward Voltage ^a	V _{SD}	I _F = 30 A, V _{GS} = 0 V		1.0	1.5	V	
Reverse Recovery Time	t _{rr}			60	100	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 30 A, di/dt = 100 A/µs		5	8	А	
Reverse Recovery Charge	Q _{rr}			0.15	0.4	μC	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

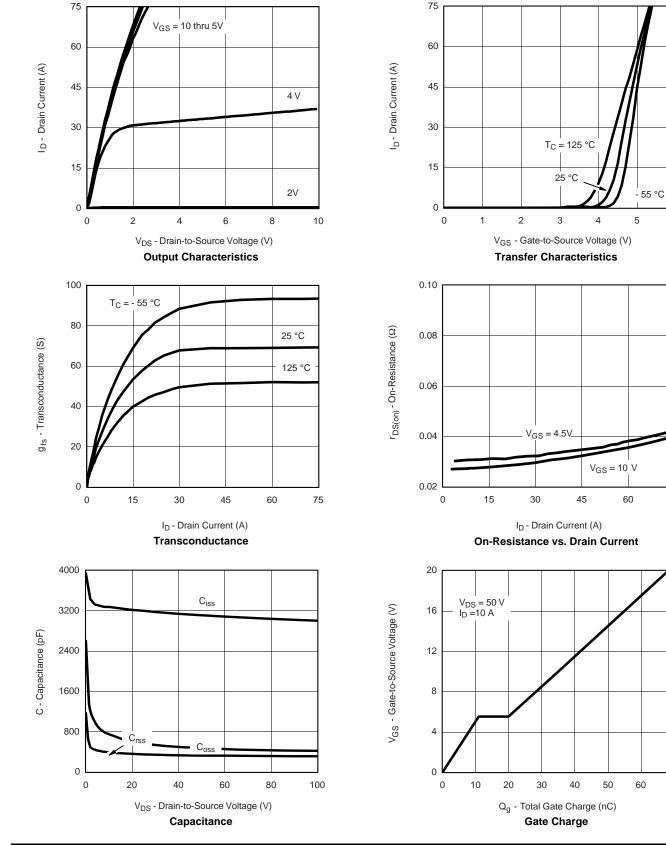
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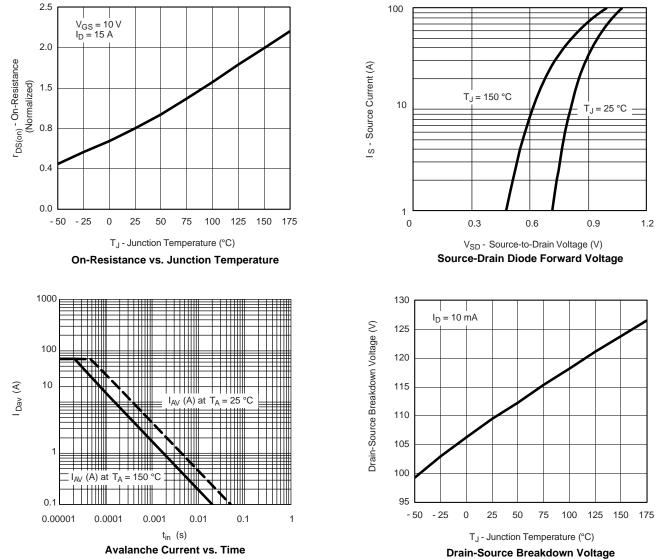
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

服务热线:400-655-8788

70



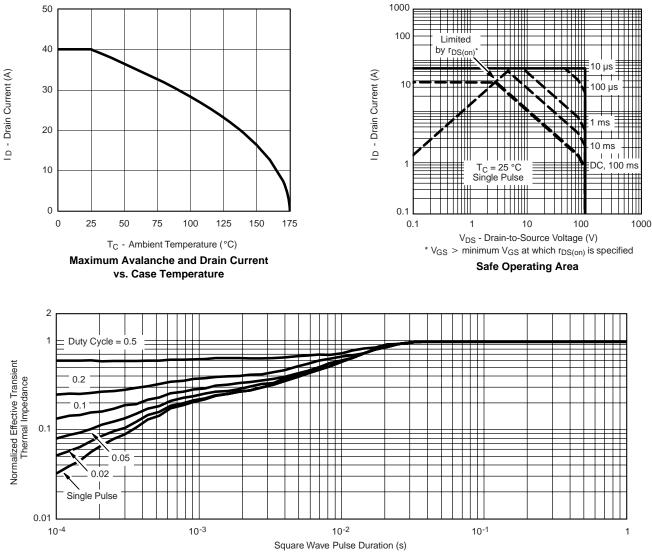
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



vs. Junction Temperature



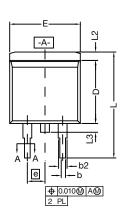
THERMAL RATINGS

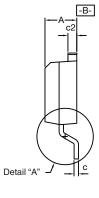


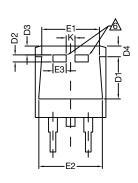
Normalized Thermal Transient Impedance, Junction-to-Case



TO-263 (D²PAK): 3-LEAD

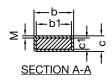








DETAIL A (ROTATED 90°)



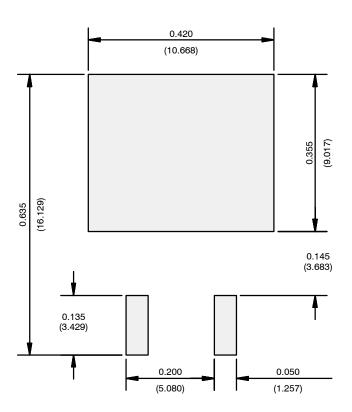
		INCHES		MILLIMETERS		
DIM.		MIN.	MAX.	MIN.	MAX.	
A		0.160	0.190	4.064	4.826	
b		0.020	0.039	0.508	0.990	
	b1	0.020	0.035	0.508	0.889	
	b2	0.045	0.055	1.143	1.397	
с*	Thin lead	0.013	0.018	0.330	0.457	
C	Thick lead	0.023	0.028	0.584	0.711	
c1	Thin lead	0.013	0.017	0.330	0.431	
CI	Thick lead	0.023	0.027	0.584	0.685	
	c2	0.045	0.055	1.143	1.397	
	D	0.340	0.380	8.636	9.652	
D1		0.220	0.240	5.588	6.096	
D2		0.038	0.042	0.965	1.067	
D3		0.045	0.055	1.143	1.397	
	D4	0.044	0.052	1.118	1.321	
	E	0.380	0.410	9.652	10.414	
	E1	0.245	-	6.223	-	
	E2	0.355	0.375	9.017	9.525	
	E3	0.072	0.078	1.829	1.981	
	е	0.100	BSC	2.54	BSC	
	К	0.045	0.055	1.143	1.397	
L		0.575	0.625	14.605	15.875	
L1		0.090	0.110	2.286	2.794	
	L2	0.040	0.055	1.016	1.397	
	L3	0.050	0.070	1.270	1.778	
	L4	0.010 BSC		0.254 BSC		
	М	-	0.002	-	0.050	
ECN: T13-0707-Rev. K, 30-Sep-13 DWG: 5843						

Notes

- 1. Plane B includes maximum features of heat sink tab and plastic.
- 2. No more than 25 % of L1 can fall above seating plane by max. 8 mils.
- 3. Pin-to-pin coplanarity max. 4 mils.
- 4. *: Thin lead is for SUB, SYB.
 - Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.







Recommended Minimum Pads Dimensions in Inches/(mm)



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